

# NCE6007S-VB Datasheet N-Channel 60-V (D-S) MOSFET

| PRODUCT SUMMARY     |                                  |                                 |                       |  |  |  |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}(\Omega)$             | I <sub>D</sub> (A) <sup>d</sup> | Q <sub>g</sub> (Typ.) |  |  |  |
| 60                  | 0.025 at V <sub>GS</sub> = 10 V  | 7.6                             | 10.5 nC               |  |  |  |
| 80                  | 0.035 at V <sub>GS</sub> = 4.5 V | 6.5                             |                       |  |  |  |

## **FEATURES**

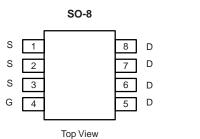
- Halogen-free According to IEC 61249-2-21 Definition
- Pb-free

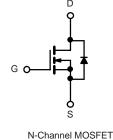
- Trench Power MOSFET
- Optimized for "Low Side" Synchronous Rectifier Operation
- 100 % R<sub>g</sub> and UIS Tested





CCFL Inverter





| Parameter   | Symbol                            | Limit           | Unit                |     |
|---|-----------------------------------|-----------------|---------------------|-----|
| Drain-Source Voltage                                | V <sub>DS</sub>                   | 60              | V                   |     |
| Gate-Source Voltage                                 |                                   | $V_{GS}$        | ± 20                | V   |
|   | T <sub>C</sub> = 25 °C            |                 | 7.6 <sup>a</sup>    |     |
| Continuous Drain Current (T <sub>.1</sub> = 150 °C) | T <sub>C</sub> = 70 °C            | 1 ,             | 6.8                 |     |
| Continuous Diam Curient (1) = 150 °C)               | T <sub>A</sub> = 25 °C            | l <sub>D</sub>  | 6.1 <sup>b, c</sup> |     |
|   | T <sub>A</sub> = 70 °C            |                 | 4.8 <sup>b, c</sup> |     |
| Pulsed Drain Current                                | •                                 | I <sub>DM</sub> | 25                  | A   |
| Ossilianos Ossilia Districtorio                     | T <sub>C</sub> = 25 °C            |                 | 4.2                 |     |
| Continuous Source-Drain Diode Current               | T <sub>A</sub> = 25 °C            | l <sub>S</sub>  | 2.1 <sup>b, c</sup> |     |
| Avalanche Current                                   |                                   | I <sub>AS</sub> | 15                  |     |
| Single-Pulse Avalanche Energy                       | L = 0.1 mH                        | E <sub>AS</sub> | 11.2                | mJ  |
|   | T <sub>C</sub> = 25 °C            |                 | 5                   |     |
| Manifestor Bernar Biodination                       | T <sub>C</sub> = 70 °C            |                 | 3.2                 | 10/ |
| Maximum Power Dissipation                           | T <sub>A</sub> = 25 °C            | P <sub>D</sub>  | 2.5 <sup>b, c</sup> | W   |
|   | T <sub>A</sub> = 70 °C            |                 | 1.6 <sup>b, c</sup> |     |
| Operating Junction and Storage Temperature Rang     | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150     | °C                  |     |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |         |      |  |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter                                   |              | Symbol            | Typical | Maximum | Unit |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 38      | 50      | °C/W |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 20      | 25      | C/VV |  |

### Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.



| Parameter                                     | Symbol                  | Test Conditions  | Min. | Тур.  | Max.  | Unit  |
|---|-------------------------|--|------|-------|-------|-------|
| Static  |                         |  | •    |       |       | •     |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$  | 60   |       |       | V     |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   |  |      | 55    |       | mV/°C |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ |  |      | - 6.3 |       |       |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$   | 1.2  |       | 2.5   | V     |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                                    |      |       | ± 100 | nA    |
| Zana Oata Valtana Brain Oamani                | I <sub>DSS</sub>        | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V  |      |       | 1     |       |
| Zero Gate Voltage Drain Current               |                         | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C                |      |       | 10    | μA    |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$                                      | 25   |       |       | Α     |
| D : 0   | _                       | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4.6 A                                       |      | 0.025 |       |       |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 4.5 \text{ V}, I_D = 4.2 \text{ A}$  |      | 0.035 |       | Ω     |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 4.6 A                                       |      | 20    |       | S     |
| Dynamic <sup>b</sup>                          |                         |  |      | •     |       |       |
| Input Capacitance                             | C <sub>iss</sub>        |  |      | 1100  |       | pF    |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                     |      | 90    |       |       |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |  |      | 55    |       |       |
| Tatal Cata Chausa                             |                         | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 4.6 \text{ A}$                |      | 21    | 32    | nC    |
| Total Gate Charge                             | $Q_g$                   |  |      | 10.5  | 16    |       |
| Gate-Source Charge                            | $Q_{gs}$                | $V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.6 \text{ A}$               |      | 3.5   |       |       |
| Gate-Drain Charge                             | Q <sub>gd</sub>         |  |      | 4.2   |       |       |
| Gate Resistance                               | R <sub>g</sub>          | f = 1 MHz  |      | 3.3   | 5     | Ω     |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |  |      | 20    | 30    |       |
| Rise Time                                     | ì,                      | $V_{DD} = 30 \text{ V}, R_{L} = 5.4 \Omega$  |      | 150   | 225   |       |
| Turn-Off DelayTime                            | t <sub>d(off)</sub>     | $I_D \cong 5.6 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$                   |      | 20    | 30    |       |
| Fall Time                                     | t <sub>f</sub>          |  |      | 60    | 90    |       |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |  |      | 10    | 15    | ns    |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD} = 30 \text{ V, R}_{L} = 5.4 \Omega$  |      | 15    | 25    |       |
| Turn-Off DelayTime                            | t <sub>d(off)</sub>     | $I_D \cong 5.6 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$                    |      | 25    | 40    |       |
| Fall Time                                     | t <sub>f</sub>          |  |      | 10    | 15    |       |
| <b>Drain-Source Body Diode Characterist</b>   | ics                     |  |      |       |       |       |
| Continous Source-Drain Diode Current          | I <sub>S</sub>          | T <sub>C</sub> = 25 °C   |      |       | 4.2   | _     |
| Pulse Diode Forward Current <sup>a</sup>      | I <sub>SM</sub>         | -  |      |       | 25    | Α     |
| Body Diode Voltage                            | V <sub>SD</sub>         | I <sub>S</sub> = 2 A   |      | 0.8   | 1.2   | V     |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         | -  |      | 25    | 50    | ns    |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         | 1 55A 41/4 400 A/4 T 0500  |      | 25    | 50    | nC    |
| Reverse Recovery Fall Time                    | t <sub>a</sub>          | $I_F = 5.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$ |      | 19    |       |       |
| Reverse Recovery Rise Time                    | t <sub>b</sub>          |  |      | 6     |       | ns    |

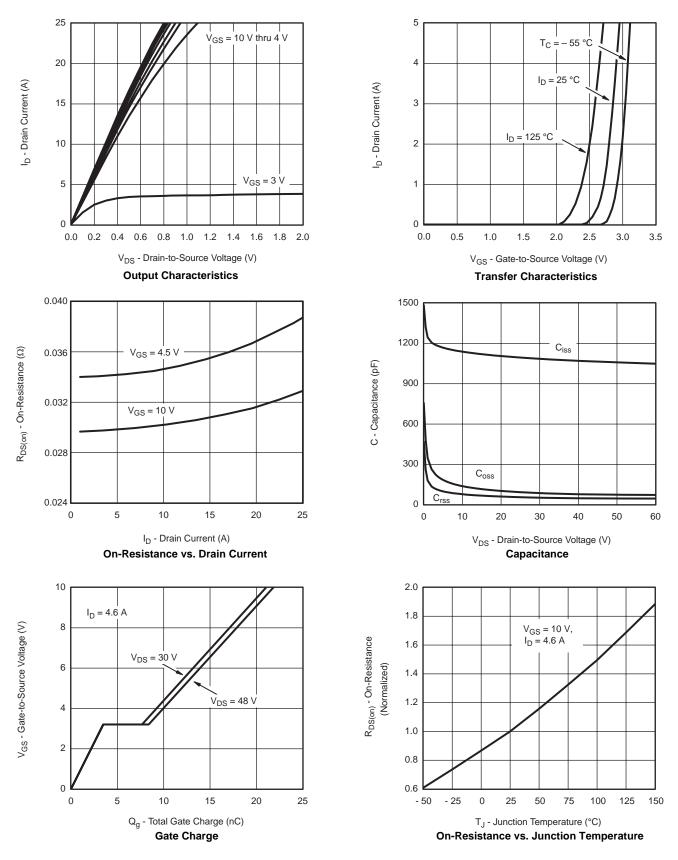
## Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

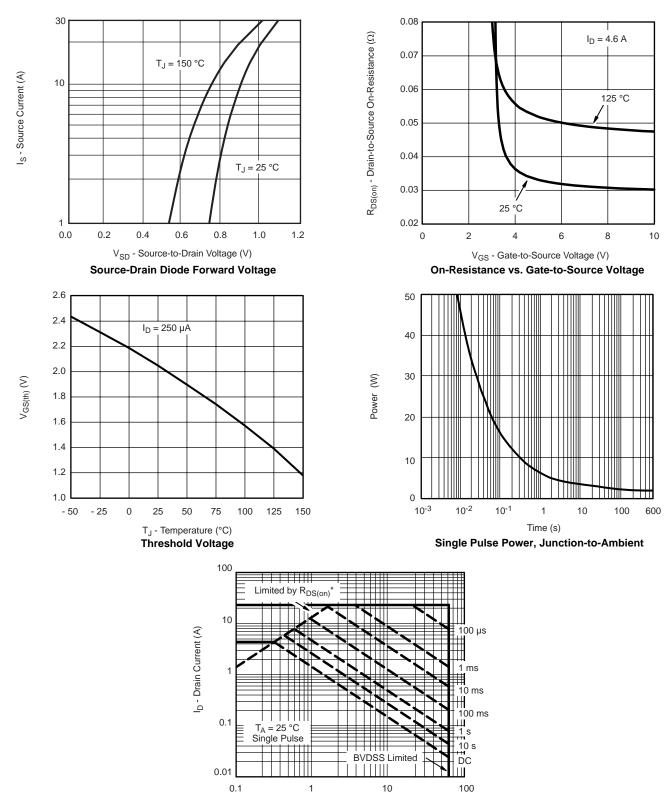
a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.





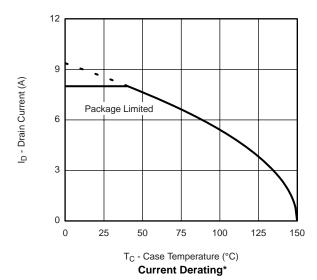


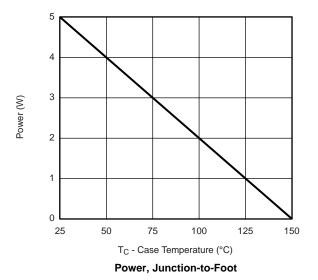


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$$\begin{split} & \text{$V_{DS}$ - Drain-to-Source Voltage (V)$} \\ ^* \text{$V_{GS}$ > minimum $V_{GS}$ at which $R_{DS(on)}$ is specified} \\ & \textbf{Safe Operating Area} \end{split}$$

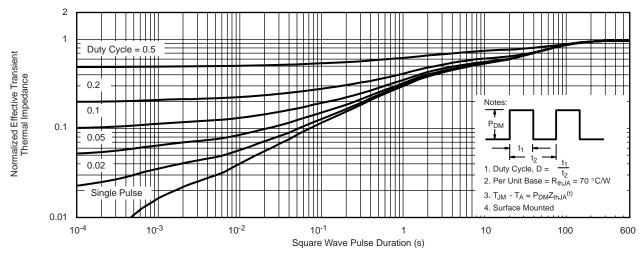




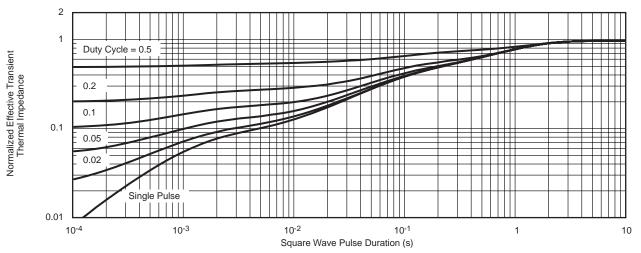


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



**SOIC (NARROW): 8-LEAD**JEDEC Part Number: MS-012







|                              | MILLIN | IETERS | INCHES    |       |  |  |
|------------------------------|--------|--------|-----------|-------|--|--|
| DIM                          | Min    | Max    | Min       | Max   |  |  |
| Α                            | 1.35   | 1.75   | 0.053     | 0.069 |  |  |
| A <sub>1</sub>               | 0.10   | 0.20   | 0.004     | 0.008 |  |  |
| В                            | 0.35   | 0.51   | 0.014     | 0.020 |  |  |
| С                            | 0.19   | 0.25   | 0.0075    | 0.010 |  |  |
| D                            | 4.80   | 5.00   | 0.189     | 0.196 |  |  |
| E                            | 3.80   | 4.00   | 0.150     | 0.157 |  |  |
| е                            | 1.27   | BSC    | 0.050 BSC |       |  |  |
| Н                            | 5.80   | 6.20   | 0.228     | 0.244 |  |  |
| h                            | 0.25   | 0.50   | 0.010     | 0.020 |  |  |
| L                            | 0.50   | 0.93   | 0.020     | 0.037 |  |  |
| q                            | 0°     | 8°     | 0°        | 8°    |  |  |
| S                            | 0.44   | 0.64   | 0.018     | 0.026 |  |  |
| ECN: C-06527-Pey I 11-Sep-06 |        |        |           |       |  |  |

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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